150-mA Low-Noise LDO Regulator With Error Flag and Discharge Option

FEATURES

- Ultra Low Dropout—130 mV at 150-mA Load
- Low Noise—75 μ$V_{(rms)}$ (10-Hz to 100-kHz Bandwidth)
- Out-of-Regulation Error Flag (power good)
- Shutdown Control
- 110-μA Ground Current at 150-mA Load
- Fast Start-Up (50 μS)
- 1.5% Guaranteed Output Voltage Accuracy (1.2 V, 2%)
- 300-mA Peak Output Current Capability
- Uses Low ESR Ceramic Capacitors
- Fast Line and Load Transient Response ($\leq$ 30 μs)
- 1-μA Maximum Shutdown Current
- Output Current Limit
- Reverse Battery Protection
- Built-in Short Circuit and Thermal Protection
- Si91842: Output—Auto-Discharge In Shutdown Mode
- Si91844: Output—No-Discharge In Shutdown Mode
- Fixed 1.2, 1.8, 2.0, 2.2, 2.5, 2.6, 2.7, 2.8, 2.85, 2.9, 3.0, 3.3, 3.5, 3.6, 5.0-V Output Voltage Options
- SOT23-5 Package

APPLICATIONS

- Cellular Phones, Wireless Handsets
- Noise-Sensitive Electronic Systems, Laptop and Palmtop Computers
- PDAs
- Pagers
- Digital Cameras
- MP3 Player
- Wireless Modem

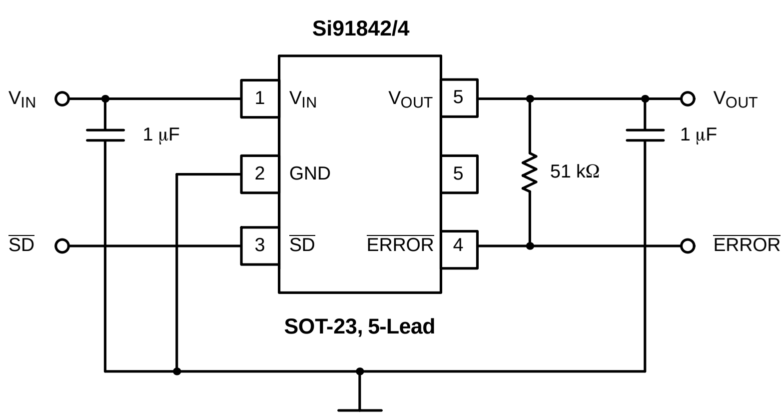
DESCRIPTION

The Si91842/4 is a 150-mA CMOS LDO (low dropout) voltage regulator. It is the perfect choice for low voltage, low power applications. An ultra low ground current and ultra fast turn-on make this part attractive for battery operated power systems. The Si91842/4 also offers ultra low dropout voltage to prolong battery life in portable electronics. Systems requiring a quiet voltage source will benefit from the Si91842/4's low output noise. The Si91842/4 is designed to maintain regulation while delivering 300-mA peak current, making it ideal for systems that have a high surge current upon turn-on.

For better transient response and regulation, an active pull-down circuit is built into the Si91842/4 to clamp the output voltage when it rises beyond normal regulation. The Si91842 automatically discharges the output voltage by connecting the output to ground through a 100-Ω n-channel MOSFET when the device is put in shutdown mode.

The Si91842/4 features reverse battery protection to limit reverse current flow to approximately 1-μA in the event reversed battery is applied at the input, thus preventing damage to the IC.

TYPICAL APPLICATION CIRCUIT



New Product

ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings
Input Voltage, V_{IN} to GND . . . . –6.0 to 6.5 V
$V_{\overline{ERROR}}$, $V_{\overline{SD}}$ (See Detailed Description) . . . . –0.3 V to V_{IN}
Output Current, I_{OUT} . . . . Short Circuit Protected
Output Voltage, V_{OUT} . . . . –0.3 V to V_{IN} + 0.3 V
Package Power Dissipation, (P_d)[b] . . . . 440 mW

Package Thermal Resistance, (θ_{JA})[a] . . . . 180°C/W
Maximum Junction Temperature, $T_{J(max)}$ . . . . 150°C
Storage Temperature, T_{STG} . . . . –65°C to 150°C

Notes
a. Device mounted with all leads soldered or welded to PC board.
b. Derate 5.5 mW/°C above T_A = 70°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING RANGE

Input Voltage, V_{IN} . . . . 2 V to 6 V
Input Voltage, $V_{\overline{SD}}$ . . . . 0 V to V_{IN}

Operating Ambient Temperature, T_A . . . . –40°C to 85°C

C_{IN} = C_{OUT} = 1 µF (ceramic)
Maximum ESR of C_{OUT}: 0.4 Ω

SPECIFICATIONS

Parameter	Symbol	Test Conditions Unless Specified T_A = 25°C, V_{IN} = $V_{OUT(nom)}$ + 1 V, I_{OUT} = 1 mA, C_{IN} = 1 µF, C_{OUT} = 1.0 µF, $V_{\overline{SD}}$ = 1.5 V		Temp[a]	Limits –40 to 85°C Min[b]	Typ[c]	Max[b]	Unit
Input Voltage Range	V_{IN}			Full	2		6	V
Output Voltage Accuracy		1 mA ≤ I_{OUT} ≤ 150 mA	V_{OUT} ≥ 1.8 V	Room	–1.5	1	1.5	%
				Full	–2.5	1	2.5	
			V_{OUT} = 1.2 V	Room	–2.0	1	2.0	
				Full	–3.0	1	3.0	
Line Regulation (V_{OUT} ≤ 3 V)	$\frac{\Delta V_{OUT} \times 100}{\Delta V_{IN} \times V_{OUT(nom)}}$	From V_{IN} = $V_{OUT(nom)}$ + 1 V to $V_{OUT(nom)}$ + 2 V		Full	–0.06		0.18	%/V
Line Regulation (3.0 V < V_{OUT} ≤ 3.6 V)				Full	0		0.3	
Line Regulation (5-V Version)		From V_{IN} = 5.5 V to 6 V		Full	0		0.4	
Dropout Voltage[d, g] ($V_{OUT(nom)}$ ≥ 2.6 V)	$V_{IN} - V_{OUT}$	I_{OUT} = 1 mA		Room		1		mV
		I_{OUT} = 50 mA		Room		45	80	
				Full		50	90	
		I_{OUT} = 150 mA		Room		130	180	
				Full			220	
Dropout Voltage[d, g] ($V_{OUT(nom)}$ < 2.6 V, V_{IN} ≥ 2 V)		I_{OUT} = 50 mA		Room		65	100	
				Full			120	
		I_{OUT} = 150 mA		Room		190	250	
				Full			300	
Ground Pin Current[e, g] ($V_{OUT(nom)}$ ≤ 3 V)	I_{GND}	I_{OUT} = 0 mA		Room		100	150	µA
				Full			180	
		I_{OUT} = 150 mA		Room		110	200	
				Full			230	
Ground Pin Current[e, g] ($V_{OUT(nom)}$ > 3 V)		I_{OUT} = 0 mA		Room		110	170	
				Full			200	
		I_{OUT} = 150 mA		Room		120	200	
				Full			230	
Peak Output current	$I_{O(peak)}$	V_{OUT} ≥ 0.95 x $V_{OUT(nom)}$, t_{PW} = 2 ms		Full	300			mA
Output Noise Voltage	e_N	V_{OUT} = 2.6 V, BW = 10 Hz to 100 kHz, 0 mA < I_{OUT} < 150 mA		Room		75		µV(rms)

SPECIFICATIONS

Parameter	Symbol	Test Conditions Unless Specified $T_A = 25°C$, $V_{IN} = V_{OUT(nom)} + 1$ V, $I_{OUT} = 1$ mA, $C_{IN} = 1$ µF, $C_{OUT} = 1.0$ µF, $V_{\overline{SD}} = 1.5$ V		Temp[a]	Limits –40 to 85°C Min[b]	Typ[c]	Max[b]	Unit
Ripple Rejection	$\Delta V_{OUT}/\Delta V_{IN}$	$I_{OUT} =$ 150 mA	f = 1 kHz	Room		60		dB
			f = 10 kHz	Room		40		
			f = 100 kHz	Room		30		
Dynamic Line Regulation	$\Delta V_{O(line)}$	V_{IN} : $V_{OUT(nom)} + 1$ V to $V_{OUT(nom)} + 2$ V $t_r/t_f = 2$ µs, $I_{OUT} = 150$ mA		Room		20		mV
Dynamic Load Regulation	$\Delta V_{O(load)}$	I_{OUT} : 1 mA to 150 mA, $t_r/t_f = 2$ µs		Room		25		
Thermal Shutdown Junction Temperature	$T_{J(S/D)}$			Room		150		°C
Thermal Hysteresis	T_{HYST}			Room		20		
Reverse current	I_R	$V_{IN} = –6.0$ V		Room		1		µA
Short Circuit Current	I_{SC}	$V_{OUT} = 0$ V		Room		700		mA
Shutdown								
Shutdown Supply Current	$I_{CC(off)}$	$V_{\overline{SD}} = 0$ V		Room		0.1	1	µA
$\overline{SD}$ Pin Input Voltage	$V_{\overline{SD}}$	High = Regulator ON (Rising)		Full	1.5		V_{IN}	V
		Low = Regulator OFF (Falling)		Full			0.4	
Auto Discharge Resistance	R_DIS	Si91842 Only		Room		100		Ω
$\overline{SD}$ Pin Input Current[f]	$I_{IN(\overline{SD})}$	$V_{\overline{SD}} = 1.5$ V, $V_{IN} = 6$ V		Room		0.7		µA
$\overline{SD}$ Hysteresis	$V_{HYST(\overline{SD})}$			Full		150		mV
V_{OUT} Turn-On Time	t_{ON}	$V_{\overline{SD}}$ (See Figure 1), $I_{LOAD} = 100$ mA		Room		50		µS
ERROR Output								
$\overline{ERROR}$ High Leakage	I_{OFF}	$\overline{ERROR} \leq V_{IN}$. V_{OUT} in Regulation		Full			1	µA
$\overline{ERROR}$ Low Voltage	V_{OL}	$I_{SINK} = 0.5$ mA		Full			0.4	V
$\overline{ERROR}$ Voltage Threshold	$V_{\overline{ERROR}}$	V_{OUT} Below $V_{OUT(nom)}$[g], $V_{IN} \geq 2$ V V_{OUT} Falling, $I_{OUT} = 1$ mA, $V_{OUT(nom)} \geq 2$ V		Full	–2	–4	–6	%
		$V_{OUT(nom)}$[g] < 2 V, $V_{IN} > 2$ V		Full		–4		
$\overline{ERROR}$ Voltage Threshold Hysteresis	$V_{HYST(\overline{ERROR})}$			Room		1.5		

Notes
a. Room = 25°C, Full = –40 to 85°C.
b. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum.
c. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
d. Dropout voltage is defined as the input to output differential voltage at which the output voltage drops 2% below the output voltage measured with a 1-V differential, provided that V_{IN} does not drop below 2.0 V.
e. Ground current is specified for normal operation as well as "drop-out" operation.
f. The device's shutdown pin includes a typical 2-MΩ internal pull-down resistor connected to ground.
g. $V_{OUT(nom)}$ is V_{OUT} when measured with a 1-V differential to V_{IN}.

TIMING WAVEFORMS

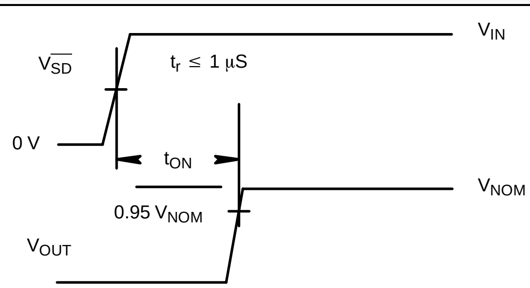
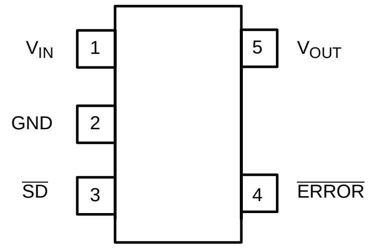


FIGURE 1. Timing Diagram for Power-Up

PIN CONFIGURATION

SOT-23, 5-Lead



PIN DESCRIPTION

Pin Number	Name	Function
1	V_{IN}	Input supply pin. Bypass this pin with a 1-μF ceramic or tantalum capacitor to ground
2	GND	Ground pin. For better thermal capability, directly connected to large ground plane
3	$\overline{SD}$	By applying less than 0.4 V to this pin, the device will be turned off. Connect this pin to V_{IN} if unused
4	$\overline{ERROR}$	The open drain output is an error flag output which goes low when V_{OUT} drops 4% below its nominal voltage.
5	V_{OUT}	Output voltage. Connect C_{OUT} between this pin and ground.

ORDERING INFORMATION

Si91842

Part Number	Marking	Voltage	Temp. Range	Pkg.
Si91842DT-12-T1[b]	J8LLL	1.2	–40 to 85°C	SOT23-5
Si91842DT-18-T1	C8LLL	1.8		
Si91842DT-20-T1	C9LLL	2.0		
Si91842DT-22-T1	C0LLL	2.2		
Si91842DT-25-T1	D1LLL	2.5		
Si91842DT-26-T1	D2LLL	2.6		
Si91842DT-27-T1	D3LLL	2.7		
Si91842DT-28-T1	D4LLL	2.8		
Si91842DT-285-T1	D5LLL	2.85		
Si91842DT-29-T1	D6LLL	2.9		
Si91842DT-30-T1	D7LLL	3.0		
Si91842DT-33-T1	D8LLL	3.3		
Si91842DT-35-T1	D9LLL	3.5		
Si91842DT-36-T1	D0LLL	3.6		
Si91842DT-50-T1	E1LLL	5.0		

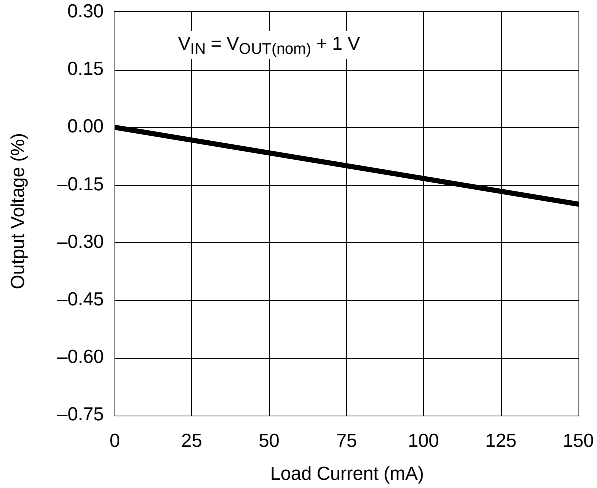
Si91844

Part Number	Marking	Voltage	Temp. Range	Pkg.
Si91844DT-18-T1	F6LLL	1.8	–40 to 85°C	SOT23-5
Si91844DT-20-T1	F7LLL	2.0		
Si91844DT-22-T1	F8LLL	2.2		
Si91844DT-25-T1	F9LLL	2.5		
Si91844DT-26-T1	F0LLL	2.6		
Si91844DT-27-T1	G1LLL	2.7		
Si91844DT-28-T1	G2LLL	2.8		
Si91844DT-285-T1	G3LLL	2.85		
Si91844DT-29-T1	G4LLL	2.9		
Si91844DT-30-T1	G5LLL	3.0		
Si91844DT-33-T1	G6LLL	3.3		
Si91844DT-35-T1	G7LLL	3.5		
Si91844DT-36-T1	G8LLL	3.6		
Si91844DT-50-T1	G9LLL	5.0		

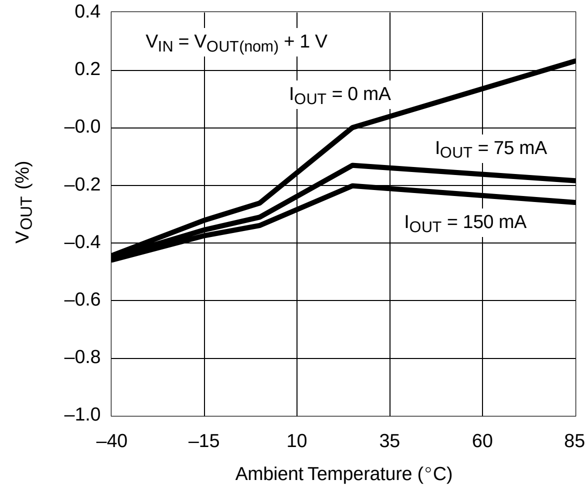
Notes:
a. LLL = Lot Code
b. Advanced Information, available March 2002.

TYPICAL CHARACTERISTICS (INTERNALLY REGULATED, 25°C UNLESS NOTED)

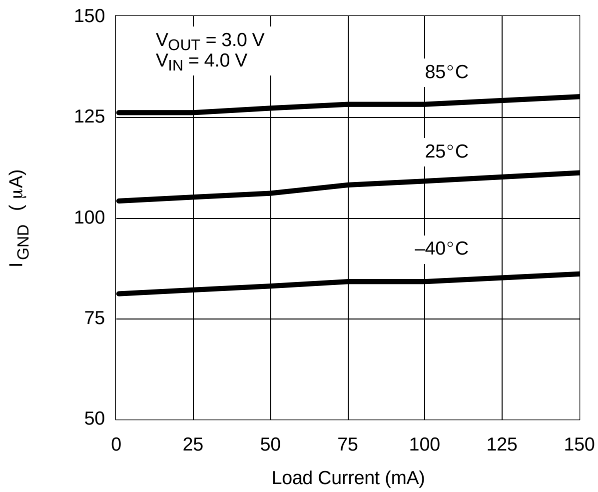
Normalized Output Voltage vs. Load Current



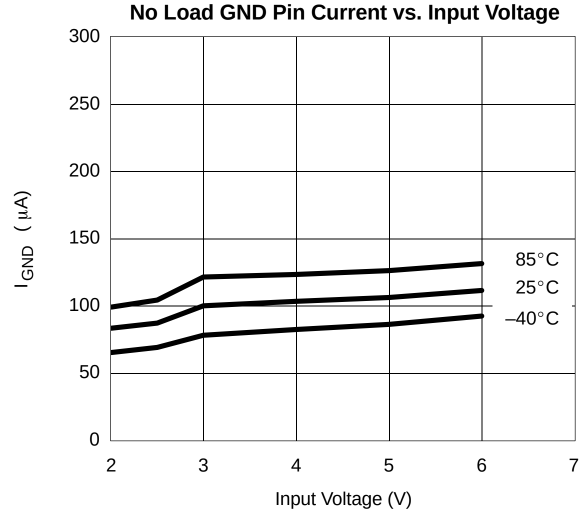
Normalized V_{OUT} vs. Temperature



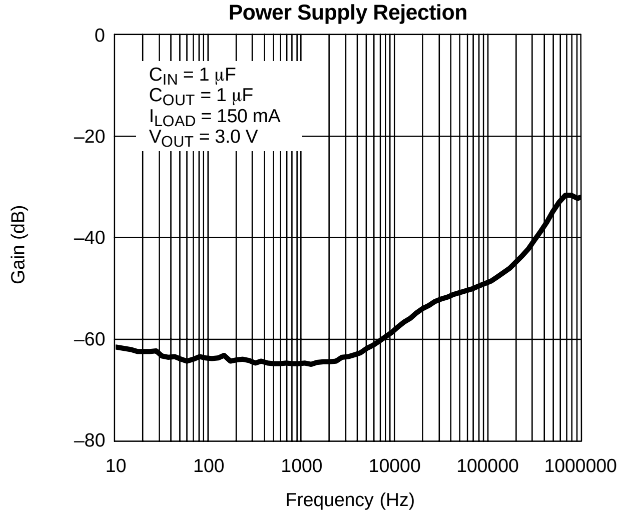
GND Current vs. Load Current



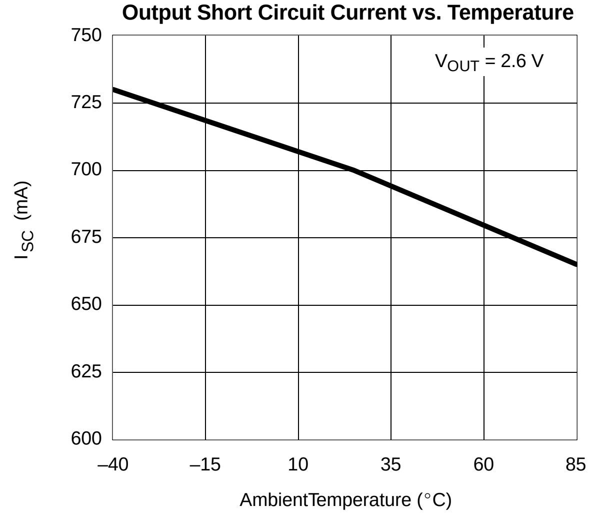
No Load GND Pin Current vs. Input Voltage



Power Supply Rejection

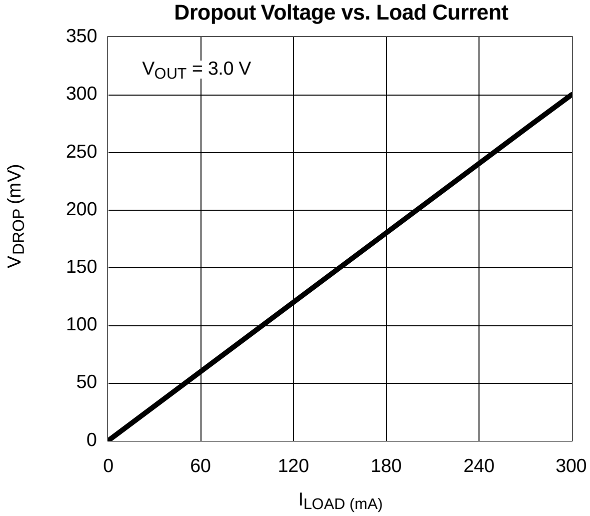


Output Short Circuit Current vs. Temperature

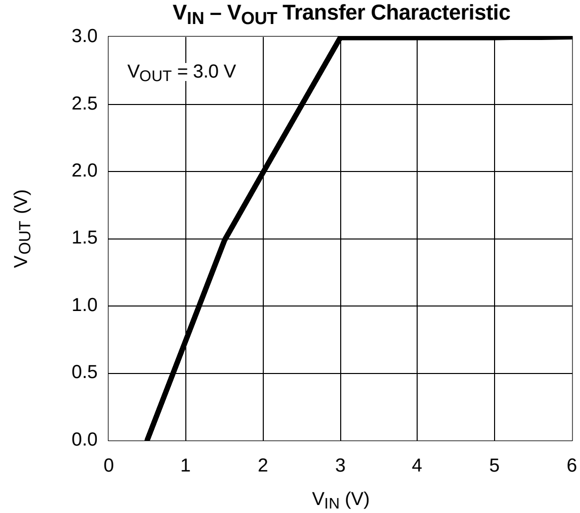


TYPICAL CHARACTERISTICS (INTERNALLY REGULATED, 25°C UNLESS NOTED)

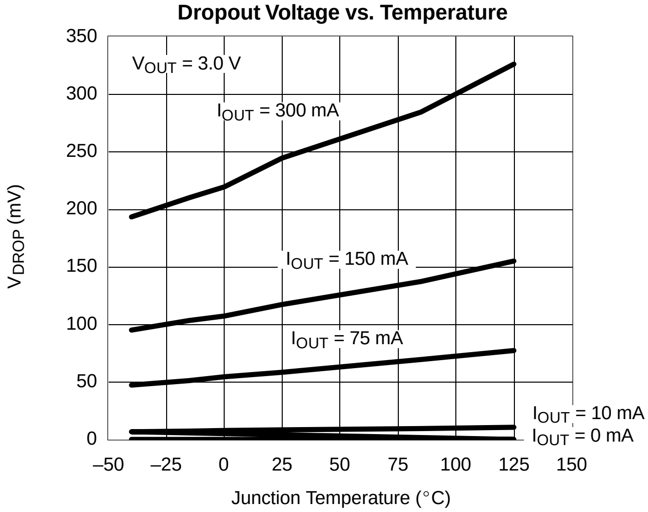
Dropout Voltage vs. Load Current



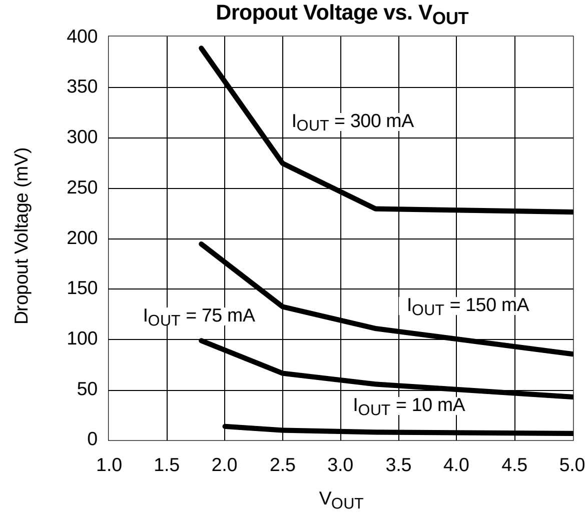
V_{IN} – V_{OUT} Transfer Characteristic



Dropout Voltage vs. Temperature

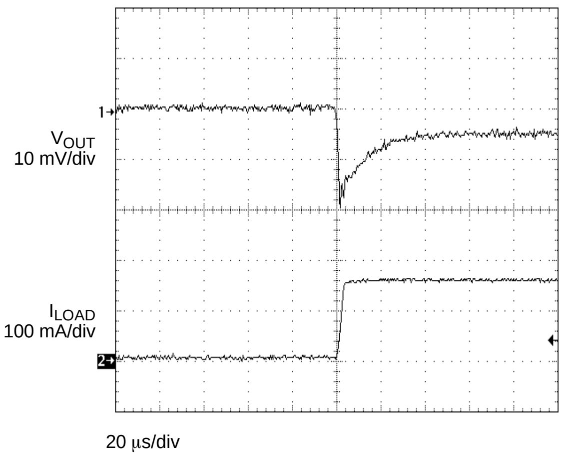


Dropout Voltage vs. V_{OUT}



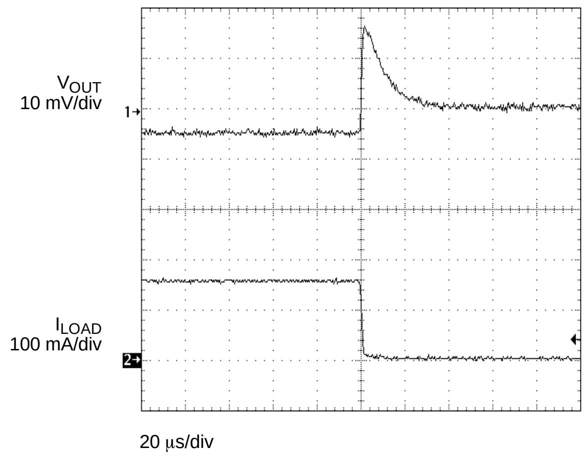
TYPICAL WAVEFORMS

Load Transient Response-1



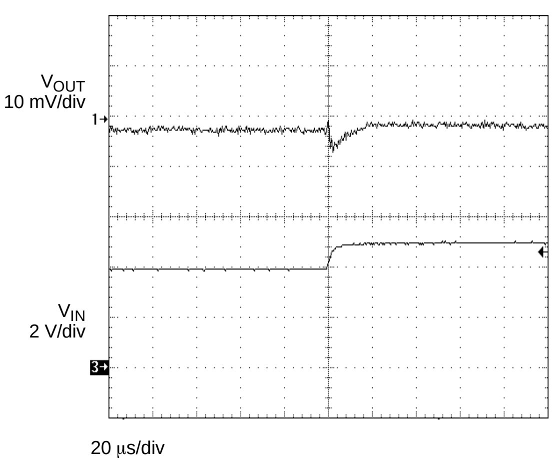
V_{OUT} = 3.0 V
C_{OUT} = 1 µF
I_{LOAD} = 1 to 150 mA
t_{rise} = 2 µsec

Load Transient Response-2



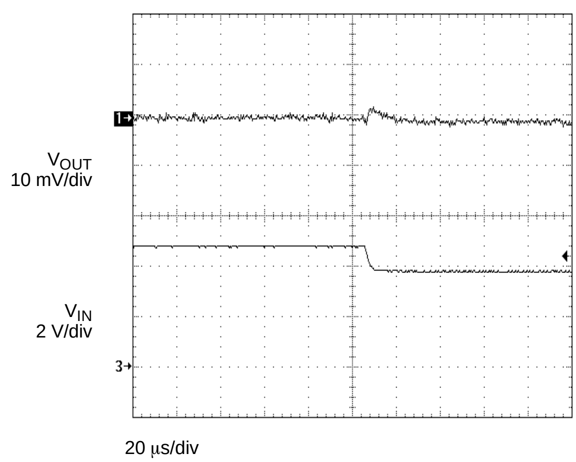
V_{OUT} = 3.0 V
C_{OUT} = 1 µF
I_{LOAD} = 150 to 1 mA
t_{fall} = 2 µsec

LineTransient Response-1



V_{INSTEP} = 4 to 5 V
V_{OUT} = 3 V
C_{OUT} = 1 µF
C_{IN} = 1 µF
I_{LOAD} = 150 mA
t_{rise} = 5 µsec

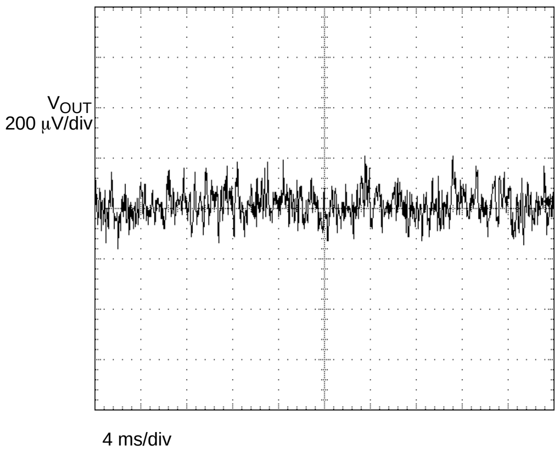
LineTransient Respons-2



V_{INSTEP} = 5 to 4 V
V_{OUT} = 3 V
C_{OUT} = 1 µF
C_{IN} = 1 µF
I_{LOAD} = 150 mA
t_{fall} = 5 µsec

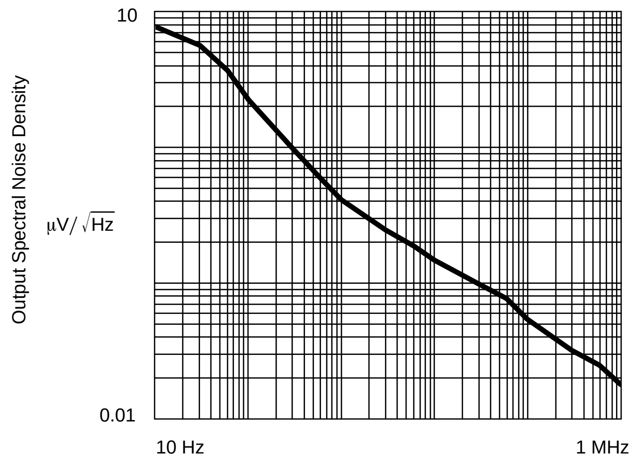
TYPICAL WAVEFORMS

Output Noise



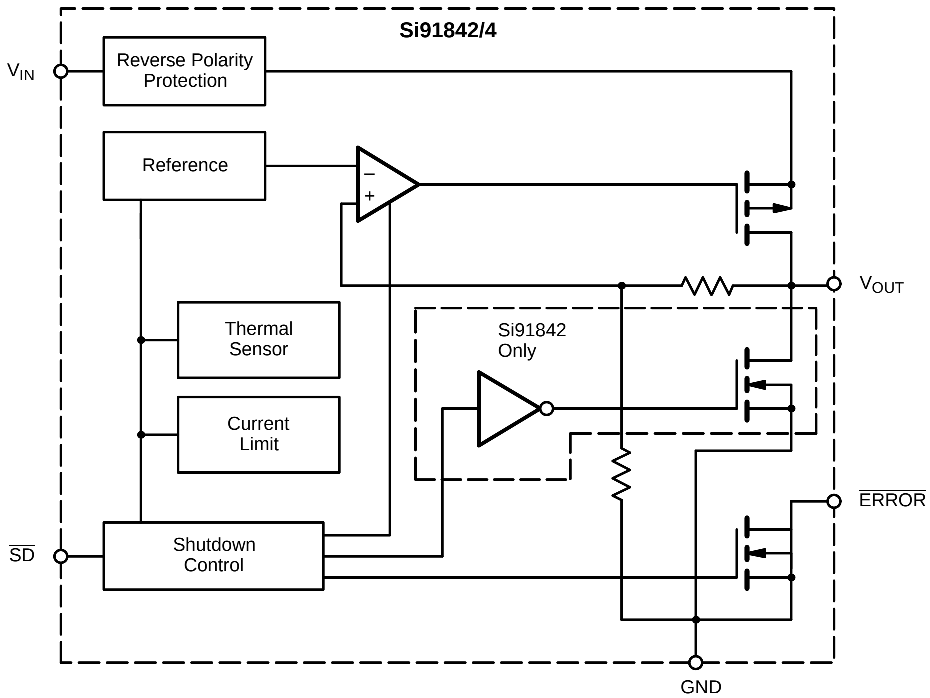
V_{IN} = 4 V
V_{OUT} = 3 V
I_{OUT} = 150 mA
BW = 10 Hz to 100 kHz

Noise Spectrum



V_{IN} = 4 V
V_{OUT} = 3 V
I_{LOAD} = 150 mA

BLOCK DIAGRAM



DETAILED DESCRIPTION

The Si91842/4 is a low-noise, low drop-out and low quiescent current linear voltage regulator, packaged in a small footprint SOT23-5 package. The Si91842/4 can supply loads up to 300 mA. As shown in the block diagram, the circuit consists of a bandgap reference, error amplifier, p-channel pass transistor and feedback resistor string. Additional blocks, not shown in the block diagram, include a precise current limiter, reverse battery and current protection, and thermal sensor.

Thermal Overload Protection

The thermal overload protection limits the total power dissipation and protects the device from being damaged. When the junction temperature exceeds 150°, the device turns the p-channel pass transistor off.

Reverse Battery Protection

The Si91842/4 has a battery reverse protection circuitry that disconnects the internal circuitry when V_{IN} drops below the GND voltage. There is no current drawn in such an event. When the $\overline{SD}$ pin is hardwired to V_{IN}, the user must connect the $\overline{SD}$ pin to V_{IN} via a 100-kΩ resistor if reverse battery protection is desired. Hardwiring the $\overline{SD}$ pin directly to the V_{IN} pin is allowed when reverse battery protection is not desired.

$\overline{ERROR}$

$\overline{ERROR}$ is an open drain output that goes low when V_{OUT} is less than 4% of its normal value. To obtain a logic level output, connect a pull-up resister from $\overline{ERROR}$ to V_{OUT} or any other voltage equal to or less than V_{IN}. $\overline{ERROR}$ pin is high impedance (off) when $\overline{SD}$ pin is low.

Auto-Discharge/No-Discharge

V_{OUT} has an internal 100-Ω (typ.) discharge path to ground when $\overline{SD}$ pin is low for the Si91842. the Si91844 does not have a discharge path when the $\overline{SD}$ pin is low.

Stability

The circuit is stable with only a small output capacitor equal to 6 nF/mA (= 1 μF @ 150 mA). Since the bandwidth of the error amplifier is around 1–3 MHz and the dominant pole is at the output node, the capacitor should be capacitive in this range, i.e., for 150-mA load current, an ESR <0.4 Ω is necessary. Parasitic inductance of about 10 nH can be tolerated.